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# Surface Mount Fast Soft Recovery Rectifier Diode, 20 A



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	20 A					
V <sub>R</sub>	200 V, 400 V, 600 V					
V <sub>F</sub> at I <sub>F</sub>	1.3 V					
I <sub>FSM</sub>	300 A					
t <sub>rr</sub>	60 ns					
T <sub>J</sub> max.	150 °C					
Snap factor	0.6					
Package	D <sup>2</sup> PAK (TO-263AB)					
Circuit configuration	Single					

#### **FEATURES**

- Glass passivated pellet chip junction
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C



- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Output rectification and freewheeling in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

#### **DESCRIPTION**

The VS-20ETF..S-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL CHARACTERISTICS VALUES UNIT						
I <sub>F(AV)</sub>	Sinusoidal waveform	20	Α			
V <sub>RRM</sub>		200 to 600	V			
I <sub>FSM</sub>		300	Α			
V <sub>F</sub>	10 A, T <sub>J</sub> = 25 °C	1.2	V			
t <sub>rr</sub>	1 A, 100 A/μs	60	ns			
T <sub>J</sub>	Range	-40 to +150	°C			

VOLTAGE RATINGS							
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA				
VS-20ETF02S-M3	200	300					
VS-20ETF04S-M3	400	500	5				
VS-20ETF06S-M3	600	700					

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 97 °C, 180° conduction half sine wave	20			
Maximum peak one cycle non-repetitive surge current	I <sub>FSM</sub>	10 ms sine pulse, rated V <sub>RRM</sub> applied	250	Α		
		10 ms sine pulse, no voltage reapplied	300			
Maximum I <sup>2</sup> t for fusing	l²t	10 ms sine pulse, rated V <sub>RRM</sub> applied	316	A <sup>2</sup> s		
Maximum 1-t for fusing	1-1	10 ms sine pulse, no voltage reapplied 442		A-S		
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	4420	A <sup>2</sup> √s		

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST C	ONDITIONS	VALUES	UNITS	
Maximum famuard valtage drap	V	20 A, T <sub>J</sub> = 25 °C		1.30	V	
Maximum forward voltage drop	V <sub>FM</sub>	60 A, T <sub>J</sub> = 25 °C		1.67	V	
Forward slope resistance	r <sub>t</sub>			12.5	mΩ	
Threshold voltage	V <sub>F(TO)</sub>	T <sub>J</sub> = 150 °C		0.9	V	
Marian and a landar and a summer	I <sub>RM</sub>	T <sub>J</sub> = 25 °C	V <sub>R</sub> = rated V <sub>RRM</sub>	0.1	mA	
Maximum reverse leakage current		T <sub>J</sub> = 150 °C		5.0		

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	· •	
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> at 20 A <sub>pk</sub>	160	ns	I <sub>FM</sub> t	
Reverse recovery current	I <sub>rr</sub>	100 A/µs	10	А	$t_a \mid t_b$	
Reverse recovery charge	Q <sub>rr</sub>	25 °C	1.25	μC	dir/Q <sub>rr</sub>	
Snap factor	S	Typical	0.6		I <sub>RM(REC)</sub>	

THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C	
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	0.9	°C/W	
Maximum thermal resistance junction to ambient (PCB mount)	R <sub>thJA</sub> (1)		40	C/VV	
Annuavimeta wajaht			2	g	
Approximate weight			0.07	oz.	
				-02S	
Marking device		Case style D <sup>2</sup> PAK (TO-263AB)	20ETF04S		
			20ETI	-06S	

### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W. For recommended footprint and soldering techniques refer to application note #AN-994

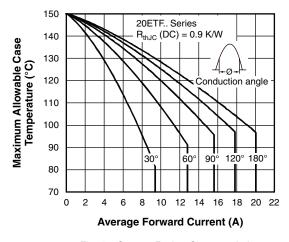


Fig. 1 - Current Rating Characteristics

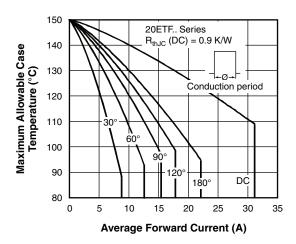


Fig. 2 - Current Rating Characteristics

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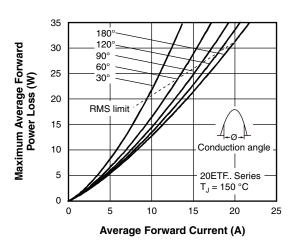


Fig. 3 - Forward Power Loss Characteristics

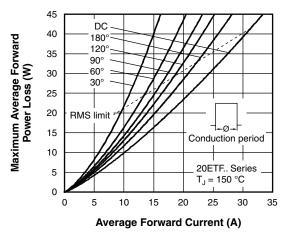


Fig. 4 - Forward Power Loss Characteristics

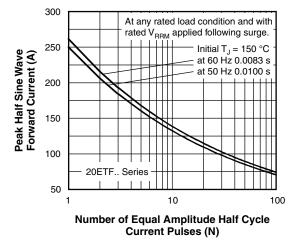


Fig. 5 - Maximum Non-Repetitive Surge Current

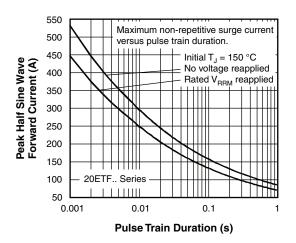


Fig. 6 - Maximum Non-Repetitive Surge Current

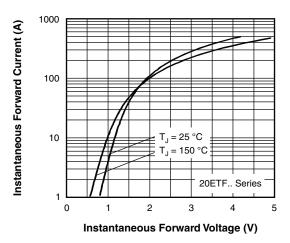


Fig. 7 - Forward Voltage Drop Characteristics

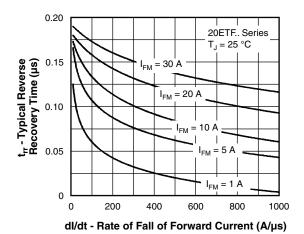


Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C



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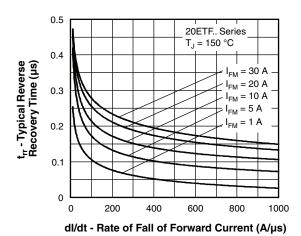


Fig. 9 - Recovery Time Characteristics,  $T_J$  = 150 °C

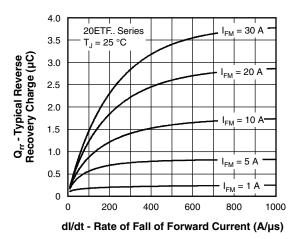


Fig. 10 - Recovery Charge Characteristics,  $T_J = 25\ ^{\circ}\text{C}$ 

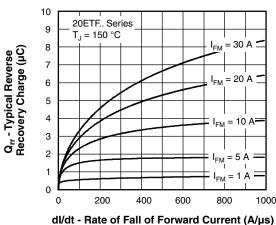
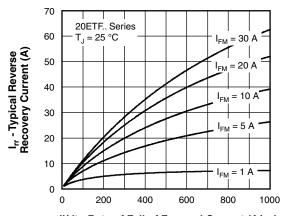


Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C



dl/dt - Rate of Fall of Forward Current (A/µs)

Fig. 12 - Recovery Current Characteristics, T<sub>J</sub> = 25 °C

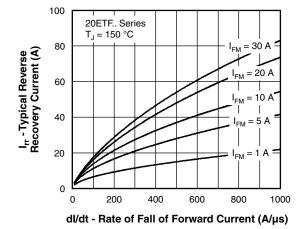


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

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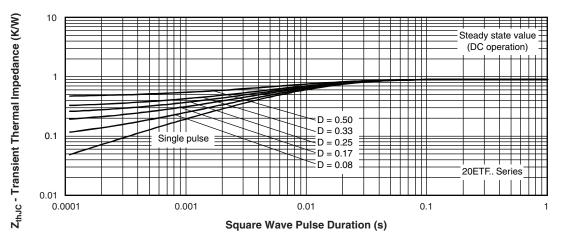
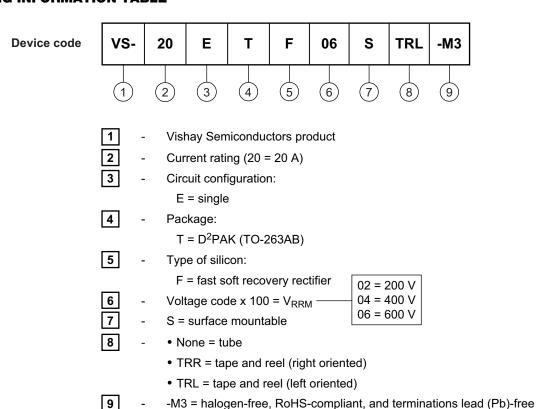


Fig. 14 - Thermal Impedance Z<sub>thJC</sub> Characteristics

### **ORDERING INFORMATION TABLE**



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ORDERING INFORMATION (Example)					
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION			
VS-20ETF02S-M3	50	Antistatic plastic tubes			
VS-20ETF02STRR-M3	800	13" diameter reel			
VS-20ETF02STRL-M3	800	13" diameter reel			
VS-20ETF04S-M3	50	Antistatic plastic tubes			
VS-20ETF04STRR-M3	800	13" diameter reel			
VS-20ETF04STRL-M3	800	13" diameter reel			
VS-20ETF06S-M3	50	Antistatic plastic tubes			
VS-20ETF06STRR-M3	800	13" diameter reel			
VS-20ETF06STRL-M3	800	13" diameter reel			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96164				
Part marking information	www.vishay.com/doc?95444				
Packaging information	www.vishay.com/doc?96424				

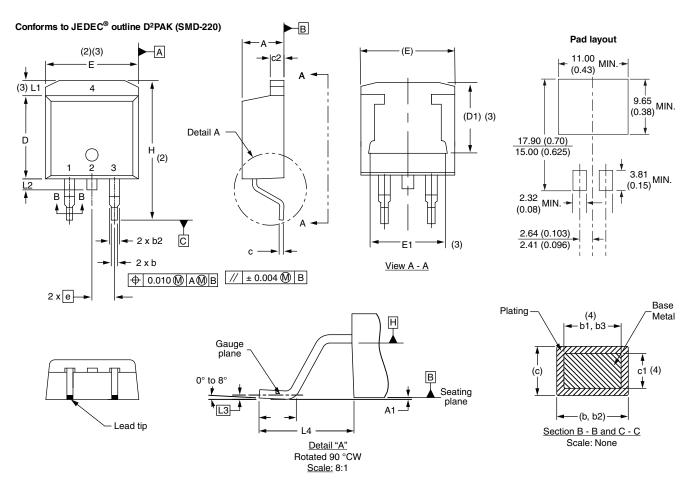
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## D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS INCHES		NOTES		
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOIES
Α	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STWBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
Е	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

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